

N-Ch MOSFET

General Description

The WSR10N65F is the highest performance trench N-Ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSR10N65F meet the RoHS and Green Product requirement , 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline

Absolute Maximum Ratings

• Green Device Available

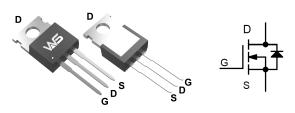
Product Summery

BV _{DSS}	R _{DSON}	I _D
650V	0.8Ω	10A

Applications

- AC/DC Power Conversion in Switched Mode Power Supplies (SMPS).
- Uninterruptible Power Supply(UPS)
- Adapter.

TO-220F Pin Configuration



Symbol **Parameter** Rating Units 650 v **Drain-Source Voltage** V_{DS} V Gate-Source Voltage ± 30 V_{GS} Continuous Drain Current, V_{GS} @ 10V^{1.5} 10 А I_D@T_C=25℃ Continuous Drain Current, V_{GS} @ 10V^{1.5} 6 I_D@T_C=100℃ А Pulsed Drain Current^{1.2.5} 40 А I_{DM} Single Pulse Avalanche Energy¹ 900 EAS mJ PD W Total Power Dissipation^{1,5} 39 Storage Temperature Range °C T_{STG} -55 to 150 °C ΤJ **Operating Junction Temperature Range** -55 to 150

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit	
R _{0JA}	Thermal Resistance Junction-ambient ¹		62.5	°C/W	
R _{θJC}	Thermal Resistance Junction-Case ¹		3.2	°C/W	



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Electrical Characteristics (T_J=25¹C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	650			V
$\triangle BV_{DSS} / \triangle T_J$	BVDSS Temperature Coefficient	Reference to 25 $^\circ\!\mathrm{C}$, I_D=250uA		0.6		V/℃
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =3.5A		0.6	0.8	Ω
V _{GS(th)}	Gate Threshold Voltage	—V _{GS} =V _{DS} , I _D =250uA	2.0	3.0	4.0	V
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient			-4.57		mV/℃
I _{DSS}	Drain-Source Leakage Current	$V_{\text{DS}}\text{=}650\text{V}$, $V_{\text{GS}}\text{=}0\text{V}$, $T_{\text{J}}\text{=}25^\circ\!\!\mathrm{C}$			1	- uA
		$V_{\text{DS}}\text{=}520\text{V}$, $V_{\text{GS}}\text{=}0\text{V}$, $T_{\text{J}}\text{=}55^\circ\!\!\mathrm{C}$			10	
I _{GSS}	Gate-Source Leakage Current	V_{GS} = $\pm30V$, V_{DS} =0V			±100	nA
gfs	Forward Transconductance	V _{DS} =40V , I _D =3.5A		5		S
Qg	Total Gate Charge (10V)			21		nC
Q _{gs}	Gate-Source Charge			7.5		
Q _{gd}	Gate-Drain Charge			6		
T _{d(on)}	Turn-On Delay Time	V _{DD} =300V , V _{GS} =10V , I _D =10A,RG=25Ω .		28		
Tr	Rise Time			70		- ns
T _{d(off)}	Turn-Off Delay Time			53		
T _f	Fall Time			35		
C _{iss}	Input Capacitance	V _{DS} =25V , V _{GS} =0V , f=1MHz		1120		
Coss	Output Capacitance			130		pF
C _{rss}	Reverse Transfer Capacitance			4.9		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,2,5}				10	А
I _{SM}	Pulsed Source Current ^{1,2}	-V _G =V _D =0V , Force Current			40	А
V _{SD}	Diode Forward Voltage ¹	V _{GS} =0V , I _S =10A , Tյ=25℃			1.4	V
t _{rr}	Reverse Recovery Time			491		nS
Qrr	Reverse Recovery Charge	IF=10A,dI/dt=40A/µs,Tյ=25℃		2296		nC

Notes:

- Note 1 : limited by maximum junction temperature.
- Note 2 : Bond wire current limit.
- Note 3 : V_{DS} =520V, I_{D} =10A.
- Note 4 : $I_D=0.5A$, $V_{DD}=50V$, $T_j=25^{\circ}C$.
- Note 5 : Repetitive Rating : Pulse width limited by maximum junction temperature.



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Typical Characteristics

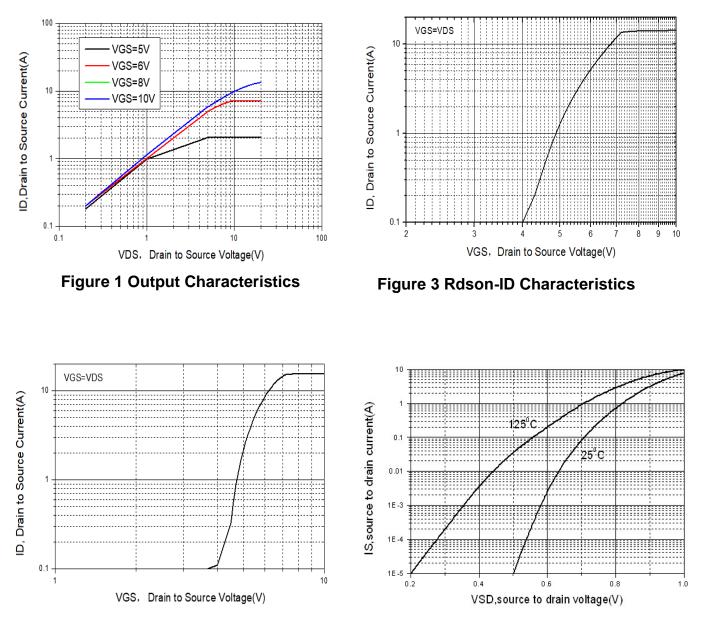


Figure 2 Transfer Characteristics





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Typical Characteristics

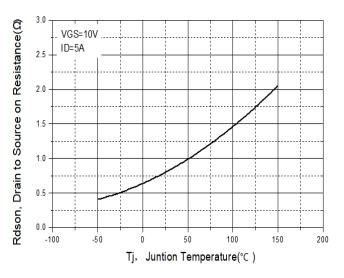
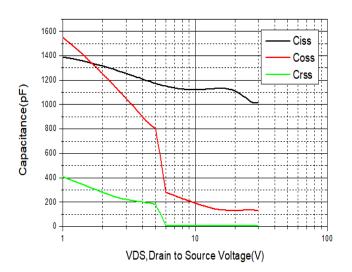
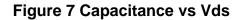


Figure 5 Rdson- Tj Relation





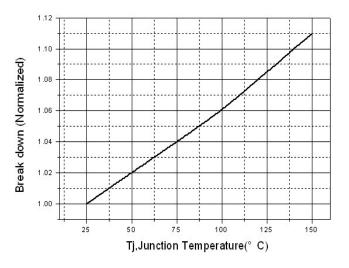


Figure 6 BVDSS vs Junction Temperature

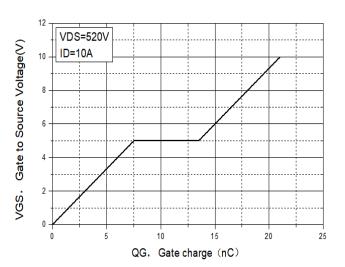
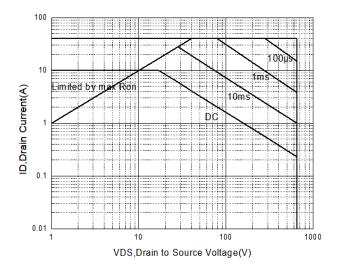


Figure 8 VGS vs QG Characteristics



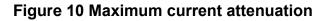
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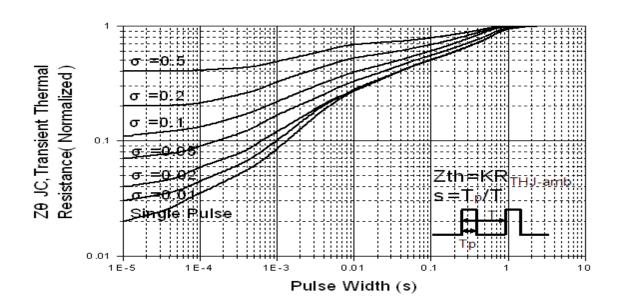
Typical Characteristics





1 40 60 80 100 120 140 TCASE (°C)





11

10 9

8

6

5 4

Drain Current(A)

<u>o</u>

Figure 11 Normalized Maximum Transient Thermal Impedance



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